## Part Number System

## Product Code

MLCC
Size Type Code
(GB/IEC/EIA)
0201; 0402; 0603; 0805; 1206;
T. C.

C0G (NP0): $0 \pm 30 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$
$-55^{\circ} \mathrm{C} \sim+125^{\circ} \mathrm{C}$
HQC:
$0 \pm 30 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$
$-55^{\circ} \mathrm{C} \sim+125^{\circ} \mathrm{C}$
X7R: $\quad \pm 15 \%$
$-55^{\circ} \mathrm{C} \sim+125^{\circ} \mathrm{C}$
X5R:
$\pm 15 \%$
$-55^{\circ} \mathrm{C} \sim+85^{\circ} \mathrm{C}$
Y5V: $\quad+22 /-82 \%$
$-30^{\circ} \mathrm{C} \sim+85^{\circ} \mathrm{C}$

## Capacitance Code

The capacitance code is expressed in pico-farads and identified by a three-digit number. The first two digits represent significant figures. The last digit specifies the number of zeros.
(Example: 104=100000pF; 4R7=4.7pF; 0R5 $=0.5 \mathrm{pF} ;$ )

## Tolerance Code

A: $\pm 0.05 \mathrm{pF}$
B: $\pm 0.1 \mathrm{pF}$
C: $\pm 0.25 \mathrm{pF}$
D: $\pm 0.5 \mathrm{pF}$
F: $\pm 1 \%$
G: $\pm 2 \%$
J: $\pm 5 \%$
K: $\pm 10 \%$
L: $\pm 15 \%$
M: $\pm 20 \%$
Z: +80/-20\%

## Rate Voltage Code

The first two digits represent significant figures, the last digit specifies the number of zeros.
$6 \mathrm{R} 3=6.3 \mathrm{~V} ; 100=10 \mathrm{~V} ; 160=16 \mathrm{~V} ; 250=25 \mathrm{~V} ; 500=50 \mathrm{~V} ; 101=100 \mathrm{~V}$

## Termination

"N" represents Ag (or Cu$) / \mathrm{Ni} / \mathrm{Sn}$ structure and " S " represents silver.

## Packaging Code

Details are shown in Table1.

## Thickness Code

Products should be marked with the Thinkness code (Named T in the below), except when describing the following: A $(0.30 \pm 0.03)$ for $0201, \mathrm{~B}(0.50 \pm 0.05)$ for $0402 \mathrm{~T}, \mathrm{D}(0.80 \pm 0.10)$ for 0603 T , Thickness code "A, B, D" can be ignore, Other products must be added the thickness of the thickness of code.

## Structure \& Dimension



Figure 1 Dimension and Cross-section of MLCC

| GB/IEC/EIA <br> $(J I S / E I A J)$ | $\mathbf{L} / \mathbf{m m}$ | $\mathbf{W} / \mathbf{m m}$ | $\mathbf{H}(\mathbf{M i n} / \mathbf{M a x}) / \mathbf{m m}$ | $\mathbf{L}_{\mathbf{1}}$ (Min/Max)/mm |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 2 0 1}$ <br> $(0603)$ | $0.6 \pm 0.03$ | $0.3 \pm 0.03$ | $0.27 / 0.33$ | $0.05 / 0.20$ |
| $\mathbf{0 4 0 2}$ <br> $(1005)$ | $1.0 \pm 0.05$ | $0.5 \pm 0.05$ | $0.45 / 0.55$ | $0.10 / 0.35$ |
| $\mathbf{0 6 0 3}$ <br> $(1608)$ | $1.6 \pm 0.10$ | $0.8 \pm 0.10$ | $0.70 / 0.90$ | $0.15 / 0.60$ |
| $\mathbf{0 8 0 5}$ <br> $(2012)$ | $2.0 \pm 0.20$ | $1.25 \pm 0.20$ | $0.50 / 1.45$ | $0.20 / 0.75$ |
| $\mathbf{1 2 0 6}$ <br> $(3216)$ | $3.2 \pm 0.20$ | $1.6 \pm 0.20$ | $0.50 / 1.80$ | $0.25 / 0.75$ |

## SUPERCAP

## Electrical Characteristics

CAPACITANCE-TEMPERATURE CHARACTERISTICS


CAPACITANCE-DC VOLTAGE BIAS CHARACTERISTICS



CAPACITANCE CHANGE-AGING

IMPEDANCE-FREQUENCY CHARACTERISTICS

※Please consult us for HF/MW MLCC


The capacitance of Class 2 dielectric changes with time. The change with time is known as "aging". It is caused by gradual realignment of the crystalline structure of the ceramic dielectric material as it is cooled below its Curie temperature, which produces a loss of capacitance with time. The aging process is predictable and follows a logarithmic decay. The aging process is reversible. If the capacitor is heated to a temperature above its Curie point for some period of time, de-aging will occur and the capacitor will regain the capacitance lost during the aging process.

The amount of de-aging depends on both the elevated temperature and the length of time at that temperature. Exposure to $150^{\circ} \mathrm{C}$ for one-half hour is sufficient to return the capacitor to its initial value. Because the capacitance changes rapidly immediately after de-aging。 capacitance measurements are indexed to a referee time of 1,000 hours. The selection of this referree time has proven practical, as the actual decline of capacitance after 1,000 hours is very low.

Specifications and Test Methods

| No | Item | Specification |  | Test Method |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Class1 | Class2 |  |
| 1 | Category temperature range | C0G: $-55^{\circ} \mathrm{C} \sim+125^{\circ} \mathrm{C}$ | $\begin{aligned} & \text { X7R: }-55^{\circ} \mathrm{C} \sim+125^{\circ} \mathrm{C} \\ & \text { X5R: }-55^{\circ} \mathrm{C} \sim+85^{\circ} \mathrm{C} \\ & \text { Y5V: }-30^{\circ} \mathrm{C} \sim+85^{\circ} \mathrm{C} \end{aligned}$ |  |
| 2 | Rated Voltage ( $\mathrm{U}_{\mathrm{R}}$ ) | See the previous |  | The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor at the rated temperature. (The sum of the DC voltage and the AC voltage applied to the capacitor should not exceed the rated voltage. The peak of the AC voltage should not exceed the value defined as the reactive power. |
| 3 | Visual Examination | No defects or abnormalities |  | Visual Inspection |
| 4 | Dimensions | Within the specified dimension. |  | Using calipers |
| 5 | Voltage Proof | $2.5 \times \mathrm{U}_{\mathrm{R}}, 1 \mathrm{~min}$, No breakdown or flashover |  | No failure shall be observed when $250 \%$ of the rated voltage is applied between the terminations for 1 minute |
| 6 | Insulation Resistances <br> (Ri) | $\begin{aligned} & \mathrm{C} 0 \mathrm{G}: \\ & \mathrm{C} \leq 10000 \mathrm{pF} \\ & \mathrm{Ri} \geq 10000 \mathrm{M} \Omega ; \\ & \mathrm{C}>10000 \mathrm{pF} \\ & \mathrm{Ri} \times \mathrm{C} \geq 100 \mathrm{M} \Omega \cdot \mathrm{Mf} \end{aligned}$ | $\begin{aligned} & \mathrm{C} \leq 0.025 \mu \mathrm{~F} \\ & \mathrm{Ri} \geq 4000 \mathrm{M} \Omega \\ & \mathrm{C}>0.025 \mu \mathrm{~F} \\ & \mathrm{Ri} \times \mathrm{C} \geq 100 \mathrm{M} \Omega \cdot \mu \mathrm{~F} \end{aligned}$ | The insulation resistance shall be measured with DC rated voltage at $15^{\circ} \mathrm{C} \sim 35^{\circ} \mathrm{C}$ and RH $25 \% \sim 80 \%$ and within $1 \mathrm{~min} \pm 5$ sof charging. |
| 7 | Capacitance | Within the specified tolerance at 500 hours |  | Test Condition: <br> Temperature: $15^{\circ} \mathrm{C} \sim 35^{\circ} \mathrm{C}$; <br> RH:25\% ~ 80\% <br> Frequency: <br> C0G: <br> $\mathrm{C} \leq 1000 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$; <br> C $>1000 \mathrm{pF}, \mathrm{f}=1 \mathrm{KHz}$ <br> X7R, X5R, Y5V: <br> $\mathrm{C} \leq 100 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$; <br> $\mathrm{C}>100 \mathrm{pF}, \mathrm{f}=1 \mathrm{KHz}$; <br> $\mathrm{C} \geq 10 \mu \mathrm{~F}, \mathrm{f}=120 \mathrm{~Hz}$ or 1 KHz 。 <br> Voltage: $1.0 \pm 0.2 \mathrm{Vrms}$ |
| 8 | Tangent of Loss Angle | $\begin{aligned} & \text { C0G: } \\ & \mathrm{C} \geq 50 \mathrm{pF}, \\ & \operatorname{tg} \delta \leq 15 \times 10^{-4} ; \\ & \mathrm{C}<50 \mathrm{pF} \\ & \operatorname{tg} \delta \leq 1.5 \times(150 / \mathrm{C}+7) \times 10^{-} \end{aligned}$ | X7R: $\begin{aligned} & \mathrm{U}_{\mathrm{R}} \geq 50 \mathrm{~V} \operatorname{tg} \delta \leq 350 \times 10^{-4} \\ & \mathrm{U}_{\mathrm{R}}=25 \mathrm{~V} \operatorname{tg} \delta \leq 350 \times 10^{-4} \\ & \mathrm{U}_{\mathrm{R}}=16 \mathrm{~V} \operatorname{tg} \delta \leq 500 \times 10^{-4} \\ & \mathrm{U}_{\mathrm{R}} \leq 10 \mathrm{~V} \operatorname{tg} \delta \leq 700 \times 10^{-4} \end{aligned}$ |  |
|  |  |  | X5R: $\begin{array}{ll} \mathrm{U}_{\mathrm{R}} \geq 25 \mathrm{~V} & \operatorname{tg} \delta \leq 750 \times 10^{-4} \\ \mathrm{U}_{\mathrm{R}}=16 \mathrm{~V} & \operatorname{tg} \delta \leq 800 \times 10^{-4} \\ \mathrm{U}_{\mathrm{R}}=10 \mathrm{~V} & \operatorname{tg} \delta \leq 900 \times 10^{-4} \\ \mathrm{U}_{\mathrm{R}}=6.3 \mathrm{~V} & \operatorname{tg} \delta \leq 1000 \times 10^{-4} \end{array}$ |  |
|  |  |  | $\begin{aligned} & \mathrm{Y} 5 \mathrm{~V}: \\ & \mathrm{U}_{\mathrm{R}} \geq 25 \mathrm{~V} \\ & \operatorname{tg} \delta \leq 500 \times 10^{-4}(\mathrm{C}<0.10 \mu \mathrm{~F}) \\ & \operatorname{tg} \delta \leq 1000 \times 10^{-4}(\mathrm{C} \geq 0.10 \mu \mathrm{~F}) \\ & \mathrm{U}_{\mathrm{R}}=16 \quad \operatorname{tg} \delta \leq 1250 \times 10^{-4} \\ & \mathrm{U}_{\mathrm{R}} \leq 10 \mathrm{~V} \quad \operatorname{tg} \delta \leq 1500 \times 10^{-4} \end{aligned}$ |  |

SUPERCAP

| 9 | Capacitance Temperature Coefficient or Temperature Characteristics |  | $\begin{gathered} \mathrm{C} 0 \mathrm{G}:: \\ \triangle \mathrm{C} / \mathrm{C} \leqslant 0 \pm 30 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{gathered}$ | X7R, X5R: $\triangle \mathrm{C} / \mathrm{C} \leqslant \pm 15 \%$ <br> Y5V: $-82 \% \leqslant \triangle C / C \leqslant+22 \%$ | Preliminary Drying 16~24hrs (C0G). <br> The temperature coefficient is calculated by the capacitance value which is measured at $25^{\circ} \mathrm{C}$ and $-55^{\circ} \mathrm{C}$ and $125^{\circ} \mathrm{C}$. <br> Special preconditioning 1 hr at $150^{\circ} \mathrm{C}$ followed by 24 hrs (X7R, X5R , Y5V). <br> The ranges of capacitance change compared with the temperature ranges $\left(\theta_{1}, 25^{\circ} \mathrm{C}, \theta_{2}\right)$ shall be within the specified ranges. <br> X7R: $\theta_{1}=-55^{\circ} \mathrm{C}, \theta_{2}=125^{\circ} \mathrm{C}$; <br> X5R: $\theta_{1}=-55^{\circ} \mathrm{C}, \theta_{2}=85^{\circ} \mathrm{C}$; <br> Y5V: $\theta_{1}=-30^{\circ} \mathrm{C}, \theta_{2}=85^{\circ} \mathrm{C}$, |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 10 | Bond strength of the termination |  | $\mathrm{C} 0 \mathrm{G}: \Delta \mathrm{C} / \mathrm{C} \leq \pm 5 \%$ or $\pm$ <br> X7R, X5R: $\Delta \mathrm{C} / \mathrm{C} \leq \pm 12$ |  | Solder the capacitor to the test jig(glass epoxy boards)shown in Fig.a using a eutectic solder. Then apply a force in the direction shown in Fig.b. The soldering shall be done with the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock. <br> t : 0.8 mm Fig: a |
| 11 | Solderability |  | $90 \%$ of the terminations is to be soldered evenly and continuously. |  | Immerse the test capacitor into a methanol solution containing rosin for 3 to 5 seconds, preheat it 150 to $180^{\circ} \mathrm{C}$ for 2 to 3 minutes and immerse it into molten solder of $235 \pm 5^{\circ} \mathrm{C}$ (or $245 \pm 5^{\circ} \mathrm{C}$ ) for $2 \pm 0.5$ s. |
|  |  | Visual | No visible damage |  | Special preconditioning 1 hr at $150^{\circ} \mathrm{C}$ followed by 24 hrs (X7R, X5R , Y5V). <br> Preheat the capacitor at $150^{\circ} \mathrm{C}$ for 1 minute. Immerse the capacitor in an eutectic solder solution at $260 \pm 5^{\circ} \mathrm{C}$ for $10 \pm 1$ seconds. Recovery it, let sit at room temperature for $6 \sim 24 \mathrm{hrs}$ (C0G) , or $24 \pm 2 \mathrm{hrs}(\mathrm{X} 7 \mathrm{R}, \mathrm{X} 5 \mathrm{R}$, Y5V) |
| 12 | Resistance to Soldering Heat | Cap. <br> Change | $\mathrm{C} 0 \mathrm{G}: \Delta \mathrm{C} / \mathrm{C} \leq \pm 2.5 \%$ or $\pm 0.25 \mathrm{Pf}$, which is larger | $\begin{aligned} & \text { X7R,X5R: }-10 \% \leq \Delta \mathrm{C} / \mathrm{C} \leq+20 \% \\ & \text { Y5V: } \Delta \mathrm{C} / \mathrm{C} \leq \pm 20 \% \end{aligned}$ |  |
| 13 | Rapid change of | Visual | No visible damage |  | Special preconditioning 1 hr at $150^{\circ} \mathrm{C}$ followed by 24 hrs (X7R, |

SUPERCAP

|  | temperature | Cap. Change | C0G: $\Delta \mathrm{C} / \mathrm{C} \leq \pm 2.5 \%$ or $\pm 0.25 \mathrm{pF}$, which is larger | $\begin{aligned} & \text { X7R, X5R: } \Delta \mathrm{C} / \mathrm{C} \leq \pm 15 \% \\ & \text { Y5V: } \Delta \mathrm{C} / \mathrm{C} \leq \pm 20 \% \end{aligned}$ | X5R, Y5V). <br> Fix the capacitor to supporting jig. According to sub-clause 4.11 of IEC60384-21/22. <br> C0G, X7R: $\theta_{1}=-55^{\circ} \mathrm{C}, \theta_{2}=125^{\circ} \mathrm{C}$; <br> X5R: $\theta_{1}=-55^{\circ} \mathrm{C}, \theta_{2}=85^{\circ} \mathrm{C}$; <br> Y5V: $\theta_{1}=-30^{\circ} \mathrm{C}, \theta_{2}=85^{\circ} \mathrm{C}$ <br> $\mathrm{t}_{1}=30 \mathrm{~min}, 5$ cycles, recovery <br> $24 \pm 2 \mathrm{hrs}$. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 14 | Adhesion | Visual | No visible damage |  | According to sub-clause 4.7 of IEC60384-21/22 $\mathrm{F}=5 \mathrm{~N}, \mathrm{t}=10 \pm 1 \mathrm{~s}$ |
| 15 | Climatic Sequence | Visual | No visible damage |  | Special preconditioning 1 hr at $150^{\circ} \mathrm{C}$ followed by 24 hrs (X7R, X5R, Y5V). <br> According to sub-clause 4.12 of IEC60384-21/22. <br> Dry Heat: $\mathrm{T}=125^{\circ} \mathrm{C}(\mathrm{C} 0 \mathrm{G}, \mathrm{X} 7 \mathrm{R})$ or $85^{\circ} \mathrm{C}$ (X5R , Y5V), $\mathrm{t}=16 \mathrm{hrs}$ Damp Heat, Cycle: First Cycle, One cycle=24hrs. <br> Cold: $\mathrm{T}=-55^{\circ} \mathrm{C}$ (C0G, X7R, X5R) or $-30^{\circ} \mathrm{C}(\mathrm{Y} 5 \mathrm{~V}), \mathrm{t}=2 \mathrm{hrs}$ <br> Damp Heat Cycle: <br> Remaining 9 Cycles <br> One cycle=24hrs. |
|  |  | Cap. Change | C0G: $\Delta \mathrm{C} / \mathrm{C} \leq \pm 5 \%$ or $\pm 0.5 \mathrm{pF}$, which is larger | $\begin{aligned} & \text { X7R, X5R: } \Delta \mathrm{C} / \mathrm{C} \leq \pm 15 \% \\ & \text { Y5V: } \Delta \mathrm{C} / \mathrm{C} \leq \pm 30 \% \end{aligned}$ |  |
|  |  | Tangent of loss angle | $\begin{aligned} & \mathrm{C} 0 \mathrm{G}: \\ & \operatorname{tg} \delta \leq 30 \times 10^{-4} \\ & (\mathrm{C} \geq 50 \mathrm{pF}) \\ & \text { or } 3 \times(150 / \mathrm{C}+7) \times 10^{-4} \\ & (\mathrm{C}<50 \mathrm{pF}) \end{aligned}$ | $$ |  |
|  |  | Insulation Resistances | C0G: <br> $\mathrm{Ri} \geq 2500 \mathrm{M} \Omega$ or $\mathrm{Ri} \times \mathrm{C} \geq 25 \mathrm{M} \Omega \cdot \mu \mathrm{F}$ which is smaller | X7R, X5R ,Y5V: <br> $\mathrm{Ri} \geq 1000 \mathrm{M} \Omega$ or <br> $\mathrm{Ri} \times \mathrm{C} \geq 5 \mathrm{M} \Omega \cdot \mu \mathrm{F}$ <br> which is smaller |  |
| 16 | Damp Heat, Steady State | Visual | No visible damage |  | Special preconditioning 1 hr at $150^{\circ} \mathrm{C}$ followed by 24 hrs (X7R, X5R, Y5V). <br> According to sub-clause 4.13 of IEC60384-21/22. <br> Test Temperature: <br> $60^{\circ} \mathrm{C} \pm 2^{\circ} \mathrm{C}$ <br> RH 90~95\% <br> Duration:21d, recovery <br> $24 \pm 2 \mathrm{hrs}$. |
|  |  | Cap. Change | C0G: $\Delta \mathrm{C} / \mathrm{C} \leq \pm 5 \%$ or $\pm 0.5 \mathrm{pF}$, which is larger | $\begin{aligned} & \text { X7R , X5R: } \Delta \mathrm{C} / \mathrm{C} \leq \pm 15 \% \\ & \text { Y5V: } \quad \Delta \mathrm{C} / \mathrm{C} \leq \pm 30 \% \end{aligned}$ |  |
|  |  | Tangent of loss angle | $\begin{aligned} & \text { C0G: } \\ & \operatorname{tg} \delta \leq 30 \times 10^{-4} \\ & (\mathrm{C} \geq 50 \mathrm{pF}) \\ & \text { or } 3 \times(150 / \mathrm{C}+7) \times 10^{-4} \\ & (\mathrm{C} \leq 50 \mathrm{pF}) \end{aligned}$ | ```X7R: \(\operatorname{tg} \delta \leq 700 \times 10^{-4}\) X5R: \(\operatorname{tg} \delta \leq 1250 \times 10^{-4}\) Y5V: \(\mathrm{U}_{\mathrm{R}} \geq 25 \mathrm{~V} \operatorname{tg} \delta \leq 750 \times 10^{-4} \mathrm{c}<0.1 \mu \mathrm{~F}\) \(\operatorname{tg} \delta \leq 1250 \times 10^{-4} \quad \mathrm{c} \geq 0.1 \mu \mathrm{~F}\) \(\mathrm{U}_{\mathrm{R}}=16 \mathrm{~V} \quad \operatorname{tg} \delta \leq 1500 \times 10^{-4}\) \(\mathrm{U}_{\mathrm{R}}=10 \mathrm{~V} \quad \operatorname{tg} \delta \leq 2000 \times 10^{-4}\)``` |  |
|  |  | Insulation <br> Resistances | C0G: <br> $\mathrm{Ri} \geq 2500 \mathrm{M} \Omega$ or <br> $\mathrm{Ri} \times \mathrm{C} \geq 25 \mathrm{M} \Omega \cdot \mu \mathrm{F}$ <br> which is smaller | X7R, X5R , Y5V: <br> $\mathrm{Ri} \geq 1000 \mathrm{M} \Omega$ or <br> $\mathrm{Ri} \times \mathrm{C} \geq 5 \mathrm{M} \Omega \cdot \mu \mathrm{F}$ <br> which is smaller |  |
| 17 | Vibration | No visible d Cap. Change C0G: $\Delta \mathrm{C} / \mathrm{C}$ <br> X7R, X5R: <br> Y5V: $\Delta \mathrm{C} / \mathrm{C} \leq$ <br> $\operatorname{tg} \delta$ : as in No | nage. <br> $\pm 2.5 \%$ or $\pm 0.25 \mathrm{pF}, \quad$ whi $\begin{aligned} & \mathrm{C} / \mathrm{C} \leq \pm 15 \% \\ & \pm 20 \% \end{aligned}$ | is larger | According to Test Fc of IEC60068-2-6. Sample shall be mounted on a suitable substrate, the amplitude of 1.5 mm , the frequencies from 10 to 55 Hz , and back to 10 Hz in about 1 min , Repeat this for 2 hrs each in 3 perpendicular direction, total 6hrs. |

SUPERCAP

| 18 | Endurance | Visual | No visible damage |  | Special preconditioning 1 hr at $150^{\circ} \mathrm{C}$ followed by 24 hrs (X7R, X5R, Y5V). <br> According to sub-clause 4.14 of IEC60384-21/22. <br> Test Temperature: <br> $125^{\circ} \mathrm{C}$ (C0G, X7R) <br> or $85^{\circ} \mathrm{C}$ (X5R, Y5V) <br> Duration: 1000 hrs <br> Voltage: $1.5 \times \mathrm{U}_{\mathrm{R}}$ *. <br> under the room temperature, recover $6 \sim 24 \mathrm{hr}$ (C0G) or $24 \pm 2 \mathrm{hr}$ (X7R,X5R,Y5V) before checking the visual and testing the electric characteristics. <br> For $\mathrm{Y} 5 \mathrm{~V} \geq 1.0 \mu \mathrm{~F}$, do special preconditioning 1 hr at $150^{\circ} \mathrm{C}$ after taking out from the test box, recover $24 \pm 2$ hours, and then test the electric characteristics. <br> * Some high-Capacity products using $1.0 \times \mathrm{U}_{\mathrm{R}}$, detailed specifications, please to our sales representatives or engineers consulting |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Cap. Change | C0G: $\Delta \mathrm{C} / \mathrm{C} \leq \pm 3 \%$ or $\pm 0.5 \mathrm{pF}$, which is larger | $\begin{aligned} & \text { X7R }, \mathrm{X} 5 \mathrm{R}: \Delta \mathrm{C} / \mathrm{C} \leq \pm 20 \% \\ & \text { Y5V: } \Delta \mathrm{C} / \mathrm{C} \leq \pm 30 \% \end{aligned}$ |  |
|  |  | Tangent of loss angle | C0G: $\begin{gathered} \operatorname{tg} \delta \leq 30 \times 10^{-4} \\ (\mathrm{C} \geq 50 \mathrm{pF}) \end{gathered}$ <br> or $3 \times(150 / \mathrm{C}+7) \times 10^{-4}$ $(\mathrm{C}<50 \mathrm{pF})$ | X7R: <br> $\operatorname{tg} \delta \leq 800 \times 10^{-4}$ <br> X5R: <br> $\operatorname{tg} \delta \leq 1250 \times 10^{-4}$ <br> Y5V: $\begin{gathered} \mathrm{U}_{\mathrm{R}} \geq 25 \mathrm{~V} \operatorname{tg} \delta \leq 750 \times 10^{-4} \quad \mathrm{c}<0.1 \mu \mathrm{~F} \\ \operatorname{tg} \delta \leq 1250 \times 10^{-4} \quad \mathrm{c} \geq 0.1 \mu \mathrm{~F} \\ \mathrm{U}_{\mathrm{R}}=16 \mathrm{~V} \quad \operatorname{tg} \delta \leq 1500 \times 10^{-4} \\ \mathrm{U}_{\mathrm{R}}=10 \mathrm{~V} \quad \operatorname{tg} \delta \leq 2000 \times 10^{-4} \end{gathered}$ |  |
|  |  | Insulation <br> Resistances | C0G: <br> $\mathrm{Ri} \geq 4000 \mathrm{M} \Omega$ or $\mathrm{Ri} \times \mathrm{C} \geq 25 \mathrm{M} \Omega \cdot \mu \mathrm{F}$ which is smaller | X7R ,X5R ,Y5V: <br> $\mathrm{Ri} \geq 2000 \mathrm{M} \Omega$ or <br> $\mathrm{Ri} \times \mathrm{C} \geq 5 \mathrm{M} \Omega \cdot \mu \mathrm{F}$ <br> which is smaller |  |
| 19 | Load humidity | Visual | No visible damage |  | According to sub-clause 9.9 of JIS-C-5102 9.9: <br> measurement for high dielectric constant type (X7R, X5R, Y5V). <br> Apply $100 \%$ of the rated DC voltage at the maximum operating temperature for 1hr. Remove and set for 48 hours at room temperature.Perform initial |
|  |  | Cap. Change | C0G: $\Delta \mathrm{C} / \mathrm{C} \leq \pm 7.5 \%$ or $\pm 0.75 \mathrm{pF}$, which is smaller | X7R: $\Delta \mathrm{C} / \mathrm{C} \leq \pm 12.5 \%$ <br> X5R: $\Delta \mathrm{C} / \mathrm{C} \leq \pm 15 \%$ <br> $\mathrm{Y} 5 \mathrm{~V}: \Delta \mathrm{C} / \mathrm{C} \leq \pm 30 \%$ ( $\mathrm{Y} 5 \mathrm{~V} \geq 1.0 \mu \mathrm{~F}$ do <br> special preconditioning 1 hr at 150 ${ }^{\circ} \mathrm{C}$ after taking out from the test box, followed by $48 \pm 4$ hours, and then test the electric characteristics.) |  |
|  |  | Tangent of loss angle | $\begin{aligned} & \text { C0G: } \\ & \operatorname{tg} \delta \leq 30 \times 10^{-4} \\ & \quad(\mathrm{C} \geq 50 \mathrm{pF}) \\ & \text { or } 3 \times(150 / \mathrm{C}+7) \times 10^{-4} \\ & (\mathrm{C}<50 \mathrm{pF}) \end{aligned}$ |  | measurement. <br> Test temperature: $60 \pm 2^{\circ} \mathrm{C}$ <br> RH 90~95\% <br> Test voltage: $U_{R}$ <br> Duration: 500hr <br> under the room temperature, recover $6 \sim 24 \mathrm{hr}$ (C0G) or $24 \pm 2 \mathrm{hr}$ |
|  |  | Insulation <br> Resistances | C0G: <br> $\mathrm{Ri} \geq 2500 \mathrm{M} \Omega$ or <br> $\mathrm{Ri} \times \mathrm{C} \geq 50 \mathrm{M} \Omega \cdot \mu \mathrm{F}$ <br> Which is smaller | X7R, X5R, Y5V: <br> $\mathrm{Ri} \geq 500 \mathrm{M} \Omega$ or $\mathrm{Ri} \times \mathrm{C} \geq 25 \mathrm{M} \Omega \cdot \mu \mathrm{F}$ <br> Which is smaller | (X7R,X5R,Y5V) before checking the visual and testing the electric characteristics. |


| Packing | Chip quantity |  | Minimum length of Empty <br> compartments |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Tape | Worker (pcs) |  | Trailer | Unseal | Leader |
|  | A | 1500 |  |  |  |
|  | B | 2000 |  | 60 mm | 200 mm |
|  | C | 3000 | 160 mm |  |  |
|  | D | 4000 |  |  |  |
|  | E | 15000 |  |  |  |
|  | I | 10000 |  |  |  |

## - Performance of Taping

- Strength of Carrier Tape and Top Cover Tape
- Carrier Tape

When a tensile force 1.02 kgf is applied in the direction of unreeling the tape, the tape shall withstand this force.

- Top cover Tape

When a tensile force 1.02 kgf is applied to the tape, the tape shall withstand this force.

## - Peel Force of Top Cover Tape

Unless otherwise specified, the peel force of top cover tape shall be 10 to 60 gf when the top cover tape is pulled at a speed of $300 \mathrm{~mm} / \mathrm{min}$ with the angle between the taped during peel and the direction of unreeling maintained at 165 to $180^{\circ}$ as illustrated in Fig.


## Application of technical requirements

## Capacitor Layout on PCB:

Mechanical stress varies according to the location of chip capacitors on PCB. The recommendation for better design is as Fig.


The stress in capacitors is in the following order: $\mathrm{A}>\mathrm{B}=\mathrm{C}>\mathrm{D}>\mathrm{E}$
Pay attention not to bend or distort the PCB otherwise the chip capacitor may crack. Please refer to the following examples.
a. Not recommended:

b. Recommended:


## Solder Buildup and Soldering Methods:

## a. Examples of soldering method not recommended:



## b. Examples of soldering method recommended:



## Consideration for Automatic Placement

If the mounting head is adjusted too low, it may induce excessive stress in the chip capacitor to result in cracking. Please take following precautions:
a. Adjust the bottom dead center of the mounting head to reach on the PCB surface and not press it;
b. Adjust the mounting head pressure to be 1 to 3 N of static weight;
c. To minimize the impact energy from mounting head, it is important to provide support from the bttom side of the PCB.

|  | Not recommended | Recommended |
| :---: | :---: | :---: |
| Single-sided Mounting |  |  |
|  | Not recommended | Recommended |
| Double-sided Mounting |  |  |

## Soldering

- Flux Selection :
a. It is recommended to use a mildly activated rosin flux (less than $0.1 \mathrm{wt} \%$ chlorine). Strong flux is not recommended.
b. Please provide proper amount of flux. Excessive flux must be avoided.
c. When water-soluble flux is used, enough washing is necessary.

Recommended Soldering Profile:

- Reflow Soldering Condition



## Cautions:

a.Excessive solder will induce higher tensile force in chip capacitor when temperature changes and result in cracking. Insufficient solder may detach the capacitors from the PC board.

The ideal condition is to have solder mass controlled to $1 / 3$ to $1 / 2$ of the thickness of the capacitor

b. Soldering duration should be kept as close to recommended times as possible, because excessive duration can detrimentally affect solderability.

## -Hand Soldering Condition:



## Cautions:

a. Use a 20 W soldering iron with a maximum tip diameter of 1.0 mm
b. The soldering iron should not directly touch the capacitor.

## Notes

## Operating Temperature:

a. Do not use capacitor above the maximum allowable operating temperature.
b. Surface temperature including self heating should be below maximum operating temperature.

## Operating Voltage:

The operating voltage for capacitors must always be lower than their rated voltage.

## - Design of Land-patterns:

When the capacitors are mounted on a PCB, the amount of solder at the terminations has a direct effect on the performance of the capacitors. The greater the amount of solder, the higher the stress on the chip capacitor. Therefore, when designing land-patterns, it is necessary to consider the appropriate size and configuration of the solder pads.


Recommend land dimensions for reflow-soldering (unit: mm)

| Type |  | 0201 | 0402 | 0603 | 0805 | 1206 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Size | $L$ | 0.6 | 1.0 | 1.6 | 2.0 | 3.2 |
|  | $W$ | 0.3 | 0.5 | 0.8 | 1.25 | 1.6 |
| $A$ |  | $0.2 \sim 0.3$ | $0.45 \sim 0.55$ | $0.6 \sim 0.8$ | $1.0 \sim 1.2$ | $2.2 \sim 2.4$ |
| $B$ |  | $0.2 \sim 0.35$ | $0.40 \sim 0.50$ | $0.6 \sim 0.7$ | $0.8 \sim 0.7$ | $0.8 \sim 0.9$ |
| $C$ |  | $0.2 \sim 0.3$ | $0.45 \sim 0.55$ | $0.6 \sim 0.8$ | $0.8 \sim 1.1$ | $1.0 \sim 1.4$ |

